

# 64-Channel Serial to Parallel Converter With High Voltage Push-Pull Outputs

## Features

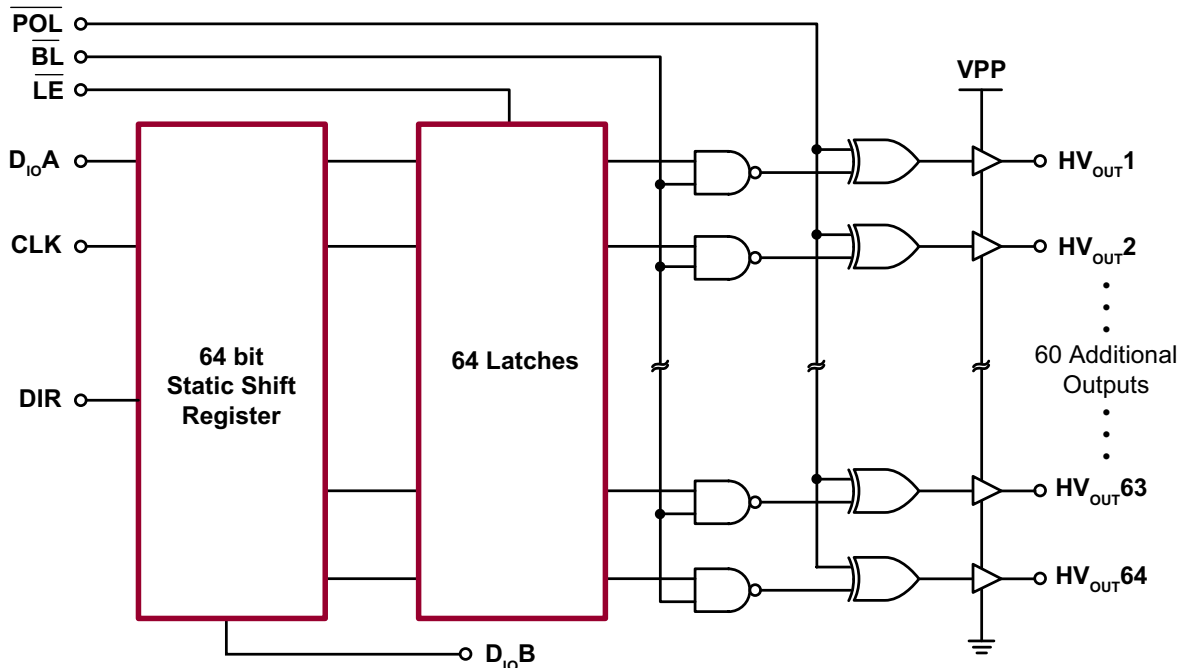
- ▶ Processed with HVCMOS® technology
- ▶ Output voltages to 180V
- ▶ Low power level shifting
- ▶ Shift register speed:
  - 6.0MHz @  $V_{DD} = 5.0V$
  - 12MHz @  $V_{DD} = 12V$
- ▶ Latched data outputs
- ▶ Output polarity and blanking
- ▶ CMOS compatible inputs
- ▶ Forward and reverse shifting options

## General Description

The HV3418 is a low voltage serial to high voltage parallel converter with push-pull outputs. This device has been designed for use as a printer driver for inkjet applications. It can also be used in any application requiring multiple output, high voltage, low current sourcing and sinking capabilities.

The device consists of a 64-bit shift register, 64 latches, and control logic to perform the polarity select and blanking of the outputs. A DIR pin controls the direction of data shift through the device. With DIR grounded,  $D_{IOA}$  is Data-In and  $D_{IOB}$  is Data-Out; data is shifted from  $HV_{OUT64}$  to  $HV_{OUT1}$ . When DIR is at logic high,  $D_{IOB}$  is Data-In and  $D_{IOA}$  is Data-Out; data is then shifted from  $HV_{OUT1}$  to  $HV_{OUT64}$ . Data is shifted through the shift register on the low to high transition of the clock. Data output buffers are provided for cascading devices. Operation of the shift register is not affected by the LE (latch enable), BL (blanking), or the POL (polarity) inputs. Transfer of data from the shift register to the latch occurs when the LE (latch enable) is high. The data in the latch is stored during LE transition from high to low.

## Functional Block Diagram

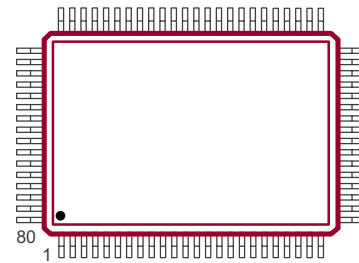


## Ordering Information

Part Number	Package Option	Packing
HV3418PG-G	80-Lead PQFP	66/Tray

-G denotes a lead (Pb)-free / RoHS compliant package

## Pin Configuration



80-Lead PQFP  
(top view)

## Absolute Maximum Ratings

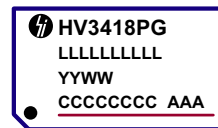
Parameter	Value
Supply voltage, $V_{DD}$	-0.5V to +15V
Output voltage, $V_{PP}$	$V_{DD}$ to +200V
Logic input levels	-0.5V to $V_{DD}$ +0.5V
Ground current <sup>1</sup>	1.5A
High voltage supply current <sup>1</sup>	1.3A
Continuous total power dissipation <sup>2</sup>	1200mW
Operating temperature range	-40°C to +85°C
Storage temperature range	-65°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to GND.

### Notes:

1. Connection to all power and ground pads is required. Duty cycle is limited by the total power dissipated in the package.
2. For operation above 25°C ambient derate linearly to maximum operating temperature at 20mW/°C.

## Product Marking



L = Lot Number  
YY = Year Sealed  
WW = Week Sealed  
C = Country of Origin  
A = Assembler ID  
— = "Green" Packaging

80-Lead PQFP

Package may or may not include the following marks: Si or

## Typical Thermal Resistance

Package	$\theta_{ja}$
80-Lead PQFP	37°C/W

## Recommended Operating Conditions

Sym	Parameter	Min	Typ	Max	Units	
$V_{DD}$	Logic supply voltage	$V_{DD} = 5.0V$	4.5	5.0	5.5	V
		$V_{DD} = 12V$	10.8	12.0	13.2	
$V_{PP}$	High voltage supply	60	-	180	V	
$V_{IH}$	High-level input voltage	$V_{DD} - 0.9$	-	$V_{DD}$	V	
$V_{IL}$	Low-level input voltage	0	-	0.9	V	
$T_A$	Operating free-air temperature	-40	-	+85	°C	

### Power-up sequence should be the following:

1. Connect ground
2. Apply  $V_{DD}$
3. Set all inputs (Data, CLK, Enable, etc.) to a known state
4. Apply  $V_{PP}$

The  $V_{PP}$  should not drop below  $V_{DD}$  or float during operation.

Power-down sequence should be the reverse of the above.

## DC Electrical Characteristics (Over recommended operating conditions unless otherwise noted)

Sym	Parameter	Min	Max	Units	Conditions
$I_{DD}$	$V_{DD}$ supply current	-	25	mA	$f_{CLK} = 12\text{MHz}$ , $f_{DATA} = 12\text{MHz}$ , $\overline{LE} = \text{low}$
$I_{DDQ}$	Quiescent $V_{DD}$ supply current	-	200	$\mu\text{A}$	All $V_{IN} = 0$ or $V_{DD}$
$I_{PP}$	High voltage supply current	-	0.50	mA	$V_{PP} = 180\text{V}$ . All outputs high.
		-	0.50		$V_{PP} = 180\text{V}$ . All outputs low.
$I_{IH}$	High-level logic input current	-	10	$\mu\text{A}$	$V_{IH} = V_{DD}$
$I_{IL}$	Low-level logic input current	-	-10	$\mu\text{A}$	$V_{IL} = 0\text{V}$
$V_{OH}$	High level output	$HV_{OUT}$	155	V	$V_{PP} = 180\text{V}$ , $I_{HV_{OUT}} = -5.0\text{mA}$ , $I_{D_{OUT}} = -100\mu\text{A}$
		$D_{OUT}$	$V_{DD} - 1.0\text{V}$		
$V_{OL}$	Low level output	$HV_{OUT}$	-	V	$V_{PP} = 180\text{V}$ , $I_{HV_{OUT}} = +5.0\text{mA}$ , $I_{D_{OUT}} = +100\mu\text{A}$
		$D_{OUT}$	-		
$V_{OC}$	$HV_{OUT}$ clamp voltage	-	$V_{DD} + 1.5$	V	$I_{OL} = +5.0\text{mA}$
		-	-1.5		$I_{OL} = -5.0\text{mA}$

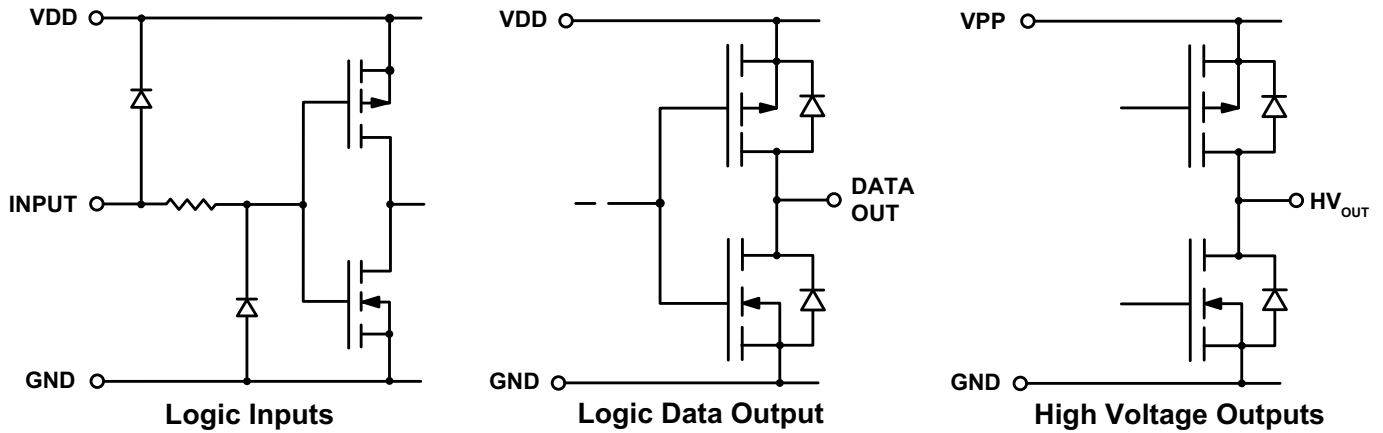
## AC Electrical Characteristics (For $V_{DD} = 12\text{V}$ . Values in parentheses are for $V_{DD} = 5.0\text{V}$ , $V_{PP} = 180\text{V}$ , $T_A = 25^\circ\text{C}$ )

Sym	Parameter	Min	Max	Units	Conditions
$f_{CLK}$	Clock frequency	-	12 (6.0)	MHz	---
$t_W$	Clock width high or low	40 (83)	-	ns	---
$t_{SU}$	Data set-up time before clock rises	25 (35)	-	ns	---
$t_H$	Data hold time after clock rises	10 (30)	-	ns	---
$t_{WLE}$	$\overline{LE}$ pulse width	62 (80)	-	ns	---
$t_{DLE}$	Delay time clock to $\overline{LE}$ high to low	25 (35)	-	ns	---
$t_{SLE}$	$\overline{LE}$ set-up time before clock rises	30 (40)	-	ns	---
$t_{ON}, t_{OFF}$	Time from $\overline{LE}$ to $HV_{OUT}$	-	1.0 (1.5)	$\mu\text{s}$	$C_L = 20\text{pF}$
$t_{DHL}$	Delay time clock to data high to low	-	50 (110)	ns	$C_L = 20\text{pF}$
$t_{DLH}$	Delay time clock to data low to high	-	75 (160)	ns	$C_L = 20\text{pF}$
$t_R, t_F$	All logic inputs	-	5.0	ns	---

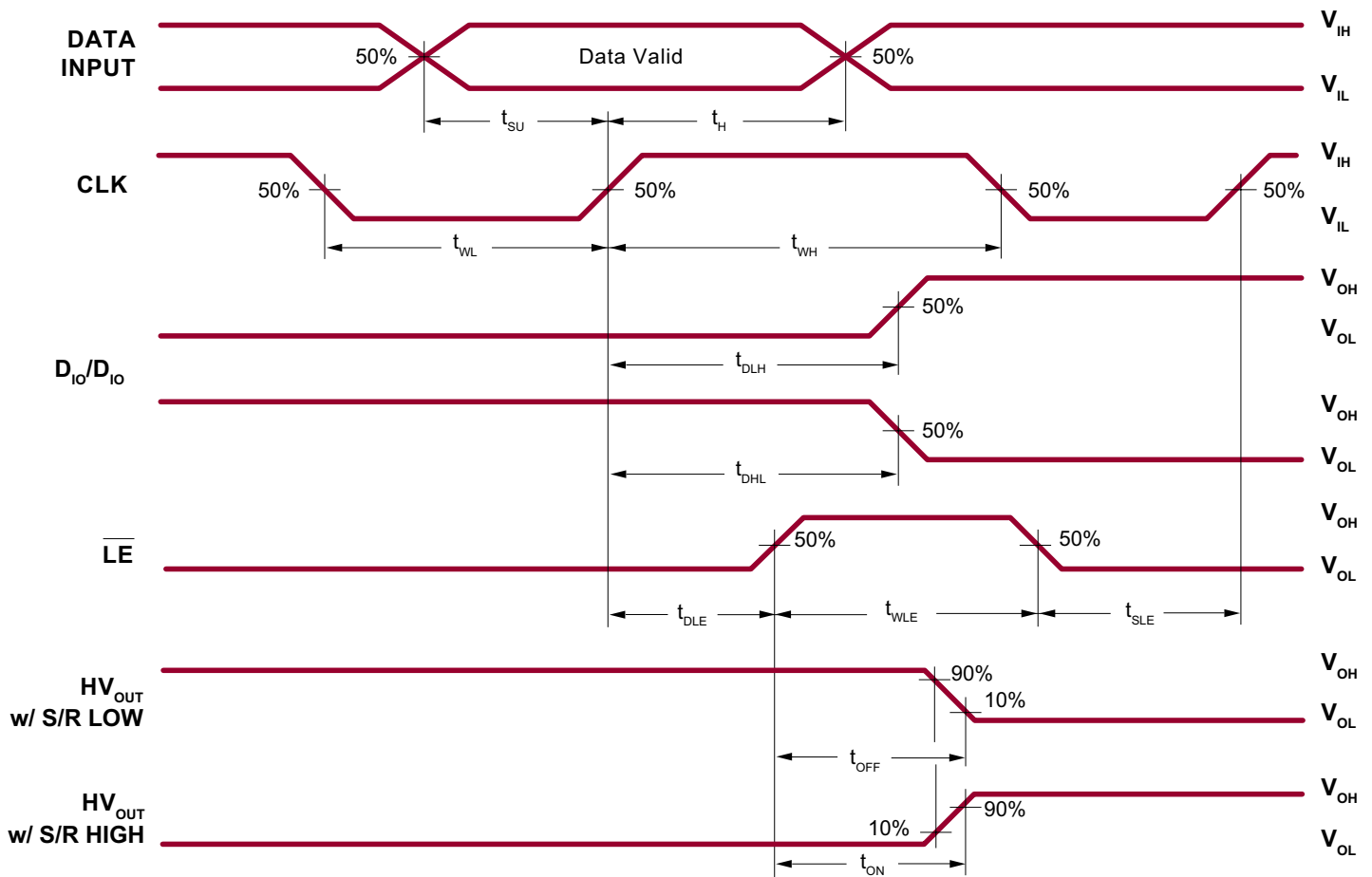
### Notes:

- Shift register speed can be as low as DC as long as data set-up and hold time meet the spec.
- AC characteristics are guaranteed only under  $V_{DD} = 12\text{V}$  and  $V_{DD} = 5.0\text{V}$ .

### Input and Output Equivalent Circuits



### Switching Waveforms



Function Table

Function	Inputs						Outputs				
	Data	CLK	$\overline{LE}$	$\overline{BL}$	$\overline{POL}$	DIR	Shift Reg		HV Outputs		Data Out *
							1	2...64	1	2...64	
All on	X	X	X	L	L	X	*	*...*	H	H...H	*
All off	X	X	X	L	H	X	*	*...*	L	L...L	*
Invert mode	X	X	L	H	L	X	*	*...*	$\overline{*}$	$\overline{*...*}$	*
Load S/R	H or L	↑	L	H	H	X	H or L	*...*	*	*...*	*
Load/store data in latches	X	X	↓	H	H	X	*	*...*	*	*...*	*
	X	X	↓	H	L	X	*	*...*	$\overline{*}$	$\overline{*...*}$	*
Transparent latch mode	L	↑	H	H	H	X	L	*...*	L	*...*	*
	H	↑	H	H	H	X	H	*...*	H	*...*	*
I/O relation	$D_{IO}A$	↑	X	X	X	L	$Q_N \rightarrow$	$Q_{N+1}$	-	-	$D_{IO}B$
	$D_{IO}B$	↑	X	X	X	H	$Q_N \rightarrow$	$Q_{N+1}$	-	-	$D_{IO}A$

Notes:

H = high level, L = low level = 0V, X = irrelevant, ↑ = low-to-high transition, ↓ = high-to-low transition.

\* = dependent on previous stage's state before the last CLK or last  $\overline{LE}$  high.

## Pin Description

Pin #	Function
1	HV <sub>OUT</sub> 41/24
2	HV <sub>OUT</sub> 42/23
3	HV <sub>OUT</sub> 43/22
4	HV <sub>OUT</sub> 44/21
5	HV <sub>OUT</sub> 45/20
6	HV <sub>OUT</sub> 46/19
7	HV <sub>OUT</sub> 47/18
8	HV <sub>OUT</sub> 48/17
9	HV <sub>OUT</sub> 49/16
10	HV <sub>OUT</sub> 50/15
11	HV <sub>OUT</sub> 51/14
12	HV <sub>OUT</sub> 52/13
13	HV <sub>OUT</sub> 53/12
14	HV <sub>OUT</sub> 54/11
15	HV <sub>OUT</sub> 55/10
16	HV <sub>OUT</sub> 56/9
17	HV <sub>OUT</sub> 57/8
18	HV <sub>OUT</sub> 58/7
19	HV <sub>OUT</sub> 59/6
20	HV <sub>OUT</sub> 60/5
21	HV <sub>OUT</sub> 61/4
22	HV <sub>OUT</sub> 62/3
23	HV <sub>OUT</sub> 63/2
24	HV <sub>OUT</sub> 64/1
25	VPP
26	D <sub>IO</sub> A
27	N/C

Pin #	Function
28	N/C
29	$\overline{\text{BL}}$
30	$\overline{\text{POL}}$
31	VDD
32	DIR
33	LGND
34	OGND
35	N/C
36	N/C
37	CLK
38	$\overline{\text{LE}}$
39	D <sub>IO</sub> B
40	VPP
41	HV <sub>OUT</sub> 1/64
42	HV <sub>OUT</sub> 2/63
43	HV <sub>OUT</sub> 3/62
44	HV <sub>OUT</sub> 4/61
45	HV <sub>OUT</sub> 5/60
46	HV <sub>OUT</sub> 6/59
47	HV <sub>OUT</sub> 7/58
48	HV <sub>OUT</sub> 8/57
49	HV <sub>OUT</sub> 9/56
50	HV <sub>OUT</sub> 10/55
51	HV <sub>OUT</sub> 11/54
52	HV <sub>OUT</sub> 12/53
53	HV <sub>OUT</sub> 13/52
54	HV <sub>OUT</sub> 14/51

Pin #	Function
55	HV <sub>OUT</sub> 15/50
56	HV <sub>OUT</sub> 16/49
57	HV <sub>OUT</sub> 17/48
58	HV <sub>OUT</sub> 18/47
59	HV <sub>OUT</sub> 19/46
60	HV <sub>OUT</sub> 20/45
61	HV <sub>OUT</sub> 21/44
62	HV <sub>OUT</sub> 22/43
63	HV <sub>OUT</sub> 23/42
64	HV <sub>OUT</sub> 24/41
65	HV <sub>OUT</sub> 25/40
66	HV <sub>OUT</sub> 26/39
67	HV <sub>OUT</sub> 27/38
68	HV <sub>OUT</sub> 28/37
69	HV <sub>OUT</sub> 29/36
70	HV <sub>OUT</sub> 30/35
71	HV <sub>OUT</sub> 31/34
72	HV <sub>OUT</sub> 32/33
73	HV <sub>OUT</sub> 33/32
74	HV <sub>OUT</sub> 34/31
75	HV <sub>OUT</sub> 35/30
76	HV <sub>OUT</sub> 36/29
77	HV <sub>OUT</sub> 37/28
78	HV <sub>OUT</sub> 38/27
79	HV <sub>OUT</sub> 39/26
80	HV <sub>OUT</sub> 40/25

**Notes:**

Pin designation for DIR = H/L

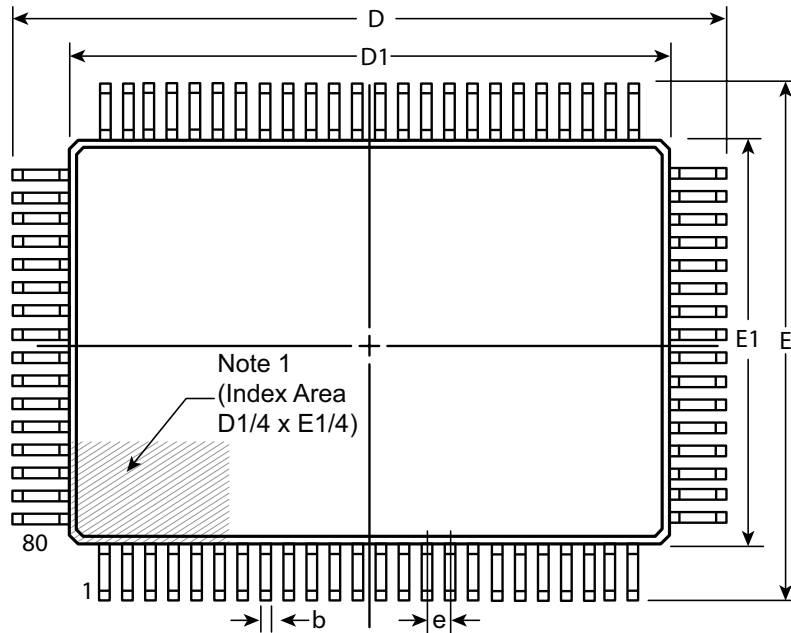
Example:

for DIR = H, Pin 1 is HV<sub>OUT</sub>41

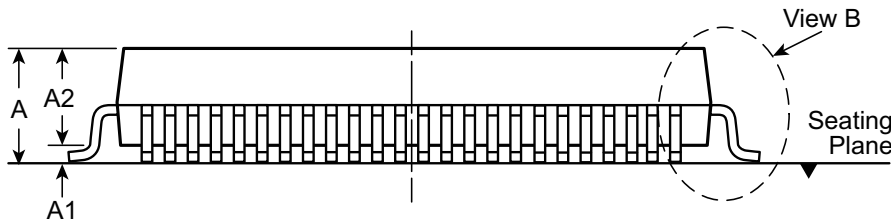
for DIR = L, Pin 1 is HV<sub>OUT</sub>24

# 80-Lead PQFP Package Outline (PG)

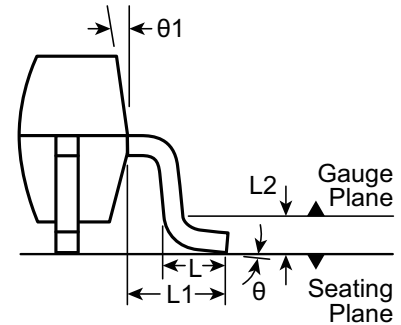
20.00x14.00mm body, 3.40mm height (max), 0.80mm pitch, 3.90mm footprint



**Top View**



**Side View**



**View B**

**Note:**  
 1. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol	A	A1	A2	b	D	D1	E	E1	e	L	L1	L2	θ	θ1	
Dimension (mm)	MIN	2.80*	0.25	2.55	0.30	23.65*	19.80*	17.65*	13.80*	0.80 BSC	0.73	1.95 REF	0.25 BSC	0°	5°
	NOM	-	-	2.80	-	23.90	20.00	17.90	14.00		0.88			3.5°	-
	MAX	3.40	0.50*	3.05	0.45	24.15*	20.20*	18.15*	14.20*		1.03			7°	16°

JEDEC Registration MO-112, Variation CB-1, Issue B, Sept. 1995.

\* This dimension is not specified in the JEDEC drawing.

**Drawings not to scale.**

**Supertex Doc. #: DSPD-80PQFP, Version C041309.**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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